



Applicant: Ho-Cheol LEE

Appl. No.: 10/803,043

Group: 2826

Filed: March 18, 2004  
SANDVIK

Examiner: Benjamin P.

For: SEMICONDUCTOR PACKAGE HAVING MULTIPLE EMBEDDED CHIPS

Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314  
**Mail Stop Issue Fee**

January 20, 2006

**AMENDMENT AFTER ALLOWANCE UNDER 37 C.F.R. § 1.312**

Sir:

In reply to the Notice of Allowance mailed October 20, 2005, the following amendment and remarks are submitted under 37 C.F.R. §1.312 in connection with the above-identified application. Applicant requests entry of these into the record and further consideration culminating in a Supplemental Notice of Allowance.

**Amendments to the Claims** begin on page 2 of this Amendment; and

**Remarks** begin on page 6 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
<b>Total</b>	18	-	18	=	0
<b>Independent</b>	3	-	3	=	0